

Date: January 10, 2024

The Secretary, BSE Limited Phiroze Jeejeebhoy Towers, Dalal Street, Mumbai – 400 001 Scrip Code: 543971

Dear Sir/Madam,

Sub: Disclosure regarding laying the foundation stone for construction of "Bondada Industrial Park by M/s. Bondada Engineering Limited" ("BONDADA") Ref: Intimation under Deschatterer

Ref: Intimation under Regulation 30 and other applicable regulations of SEBI (Listing Obligation & Disclosure Requirements) Regulations, 2015

In pursuance to Regulation 30 and other applicable regulations of the Securities and Exchange Board of India (Listing Obligations & Disclosure Requirements) Regulations, 2015, ("the Listing Regulations"), we wish to inform the stock exchange that M/s. Bondada Engineering Limited has laid the foundation stone for construction of **"Bondada Industrial Park"** at Rampally, Hyderabad, to cater global standard manufacturing facilities for its subsidiaries in the below mentioned manner:

- 1. SmartBrix Infra Technologies Private Limited
 - UPVC profile extrusion plant
 - UPVC windows
 - Aluminum Windows
- 2. Atpole Technologies Private Limited
 - Design and manufacturing of BLDC motors for electric vehicles
- 3. Bondada E&E Private Limited
 - Manufacturing of LED lights

Kindly take the aforementioned submission on your records.

Thank You,

For Bondada Engineering Limited

SATYANARA Digitally signed by SATYANARAYANA YANA BARATAM BARATAM Date: 2024.01.10 18:33:34 +05'30'

Satyanarayana Baratam Whole-time Director DIN: 02610755



Bondada Engineering Limited

(Formerly known as Bondada Engineering Pvt Ltd)

Corporate office : Plot No.11&15, 3rd Floor, Surya P.P.R. Towers, Ganesh Nagar, Kapra, Hyderabad,Telangana - 500062, INDIA. © 7207034662

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Registered office :

CIN: U28910TG2012PLC080018, Email: info@bondada.net, Website: www.bondada.net